

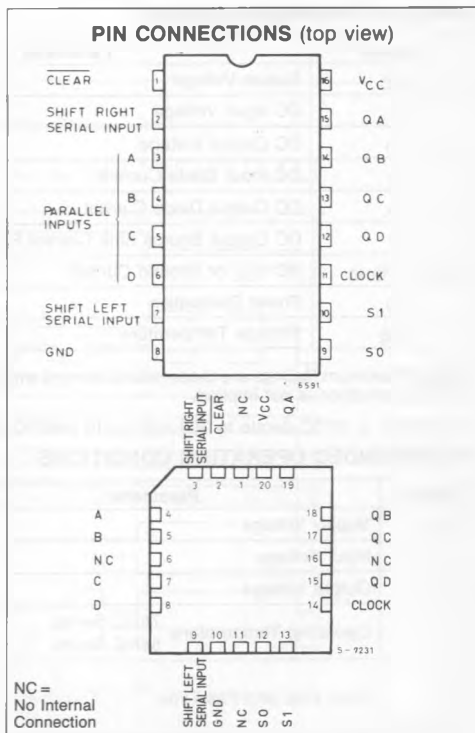
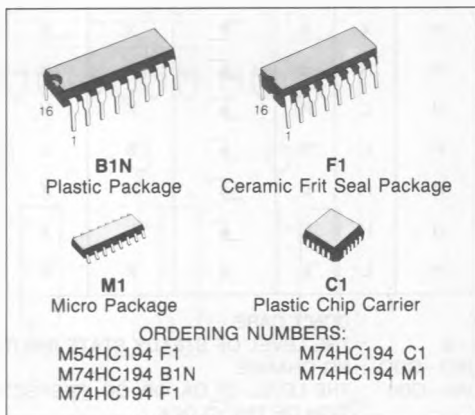
4 BIT PIPO SHIFT REGISTER

- **HIGH SPEED**
 $t_{PD} = 13 \text{ ns (TYP.) at } V_{CC} = 5V$
- **LOW POWER DISSIPATION**
 $I_{CC} = 4 \mu A \text{ (MAX.) at } T_A = 25^\circ C$
- **HIGH NOISE IMMUNITY**
 $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (MIN.)}$
- **OUTPUT DRIVE CAPABILITY**
 10 LSTTL LOADS
- **SYMMETRICAL OUTPUT IMPEDANCE**
 $|I_{OH}| = I_{OL} = 4 \text{ mA (MIN.)}$
- **BALANCED PROPAGATION DELAYS**
 $t_{PLH} = t_{PHL}$
- **HIGH NOISE IMMUNITY**
 $V_{NIH} = V_{NIL} = 28\% V_{CC} \text{ (MIN.)}$
- **WIDE OPERATING VOLTAGE RANGE**
 $V_{CC} \text{ (OPR)} = 2V \text{ to } 6V$
- **PIN AND FUNCTION COMPATIBLE**
 WITH 54/74LS194

DESCRIPTION

The M54/74HC194 is a high speed CMOS 4 BIT PIPO SHIFT REGISTER fabricated in silicon gate C²MOS technology. It has the same high speed performance of LSTTL combined with true CMOS low power consumption.

This SHIFT REGISTER is designed to incorporate virtually all of the features a system designer may want in a shift register. It features parallel inputs, parallel outputs, right shift and left shift serial inputs, clear line. The register has four distinct modes of operation: PARALLEL (broadside) LOAD; SHIFT RIGHT (in the direction Q_A Q_D); SHIFT LEFT; INHIBIT CLOCK (do nothing). Synchronous parallel loading is accomplished by applying the four data bits and taking both mode control inputs, S₀ and S₁ high. The data are loaded into their respective flip-flops and appear at the outputs after the positive transition of the CLOCK input. During loading, serial data flow is inhibited. Shift right is accomplished synchronously with the rising edge of the clock pulse when S₀ is high and S₁ is low. Serial data for this mode is entered at the SHIFT RIGHT data input. When S₀ is low and S₁ is high, data shifts left synchronously and new data is entered at the SHIFT LEFT serial input. Clocking of the flip flops is inhibited when both mode control inputs are low. The mode control inputs should be changed only when the CLOCK input is high. All inputs are equipped with protection circuits against static discharge and transient excess voltage.



TRUTH TABLE

INPUTS										OUTPUTS			
CLEAR	MODE		CLOCK	SERIAL		PARALLEL				QA	QB	QC	QD
	S1	S0		LEFT	RIGHT	A	B	C	D				
L	X	X	X	X	X	X	X	X	X	L	L	L	L
H	X	X		X	X	X	X	X	X	QA0	QB0	QC0	QD0
H	H	H		X	X	a	b	c	d	a	b	c	d
H	L	H		X	H	X	X	X	X	H	QAn	QBn	QCn
H	L	H		X	L	X	X	X	X	L	QAn	QBn	QCn
H	H	L		H	X	X	X	X	X	QBn	QCn	QDn	H
H	H	L		L	X	X	X	X	X	QBn	QCn	QDn	L
H	L	L	X	X	X	X	X	X	X	QA0	QB0	QC0	QD0

X : DON'T CARE

a ~ d : THE LEVEL OF STEADY STATE INPUT VOLTAGE AT INPUT A ~ D RESPECTIVELY

QA0 ~ QD0 : NO CHANGE

QAn ~ QDn : THE LEVEL OF QA, QB, QC, RESPECTIVELY, BEFORE THE MOST-RECENT POSITIVE TRANSITION OF THE CLOCK.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	-0.5 to 7	V
V_I	DC Input Voltage	-0.5 to $V_{CC} + 0.5$	V
V_O	DC Output Voltage	-0.5 to $V_{CC} + 0.5$	V
I_{IK}	DC Input Diode Current	± 20	mA
I_{OK}	DC Output Diode Current	± 20	mA
I_O	DC Output Source Sink Current Per Output Pin	± 25	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current	± 50	mA
P_D	Power Dissipation	500 (*)	mW
T_{stg}	Storage Temperature	-65 to 150	°C

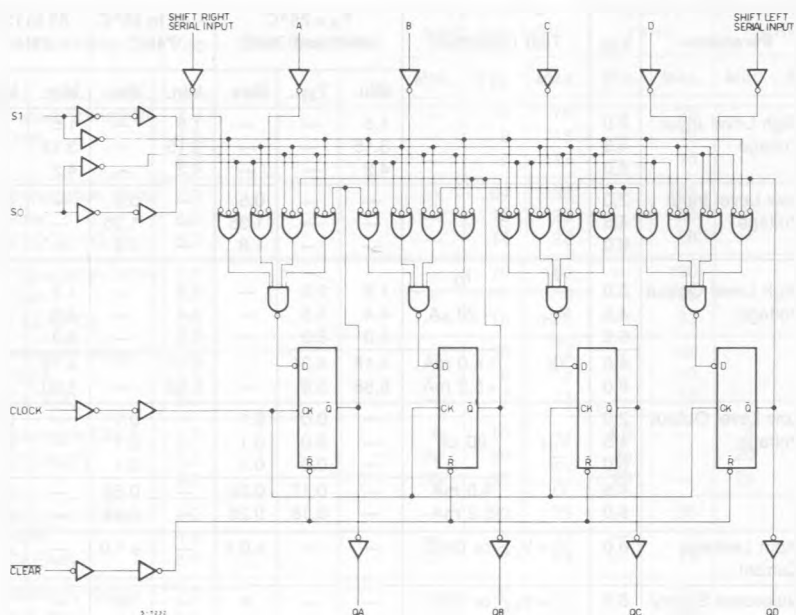
Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

(*) 500 mW: $\cong$ 65°C derate to 300 mW by 10 mW/°C: 65°C to 85°C.

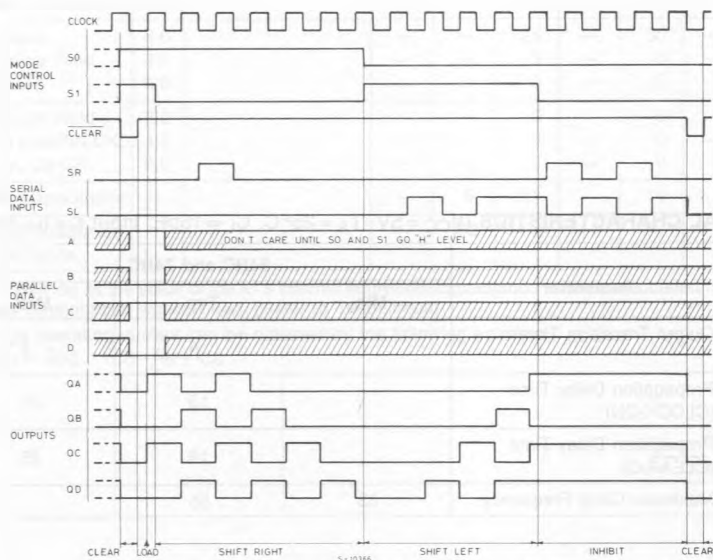
RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V_{CC}	Supply Voltage	2 to 6	V
V_I	Input Voltage	0 to V_{CC}	V
V_O	Output Voltage	0 to V_{CC}	V
T_A	Operating Temperature 74HC Series 54HC Series	-40 to 85 -55 to 125	°C
t_r, t_f	Input Rise and Fall Time	$V_{CC} \begin{cases} 2 \text{ V} & 0 \text{ to } 1000 \\ 4.5 \text{ V} & 0 \text{ to } 500 \\ 6 \text{ V} & 0 \text{ to } 400 \end{cases}$	ns

LOGIC DIAGRAM



TIMING CHART



DC SPECIFICATIONS

Symbol	Parameter	V _{CC}	Test Condition	T _A = 25°C 54HC and 74HC			- 40 to 85°C 74HC		- 55 to 125°C 54HC		Unit
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
V _{IH}	High Level Input Voltage	2.0 4.5 6.0		1.5 3.15 4.2	— — —	— — —	1.5 3.15 4.2	— — —	1.5 3.15 4.2	— — —	V
V _{IL}	Low Level Input Voltage	2.0 4.5 6.0		— — —	— — —	0.5 1.35 1.8	— — —	0.5 1.35 1.8	— — —	0.5 1.35 1.8	V
V _{OH}	High Level Output Voltage	2.0	V _I	I _O	1.9	2.0	—	1.9	—	1.9	V
		4.5	V _{IH} or V _{IL}	- 20 µA	4.4	4.5	—	4.4	—	4.4	
		6.0			5.9	6.0	—	5.9	—	5.9	
		4.5 6.0		- 4.0 mA - 5.2 mA	4.18 5.68	4.31 5.8	— —	4.13 5.63	— —	4.10 5.60	
V _{OL}	Low Level Output Voltage	2.0	V _{IH} or V _{IL}	20 µA	—	0.0	0.1	—	0.1	—	V
		4.5			—	0.0	0.1	—	0.1	—	
		6.0			—	0.0	0.1	—	0.1	—	
		4.5 6.0		4.0 mA 5.2 mA	— —	0.17 0.18	0.26 0.26	— —	0.33 0.33	— —	0.40 0.40
I _I	Input Leakage Current	6.0	V _I = V _{CC} or GND		—	—	±0.1	—	±1.0	—	µA
I _{CC}	Quiescent Supply Current	6.0	V _I = V _{CC} or GND		—	—	4	—	40	—	80 µA

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 5V, T_A = 25°C, C_L = 15pF, Input t_r = t_f = 6ns)

Symbol	Parameter	54HC and 74HC			Unit
		Min.	Typ.	Max.	
t _{TLH} t _{THL}	Output Transition Time		4	8	ns
t _{PLH} t _{PHL}	Propagation Delay Time (CLOCK-QN)		13	21	ns
t _{PHL}	Propagation Delay Time (CLEAR-Q)		16	25	ns
f _{MAX}	Maximum Clock Frequency	33	55		MHz

AC ELECTRICAL CHARACTERISTICS ($C_L = 50\text{pF}$, Input $t_r = t_f = 6\text{ns}$)

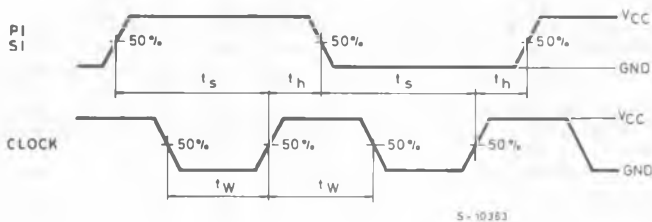
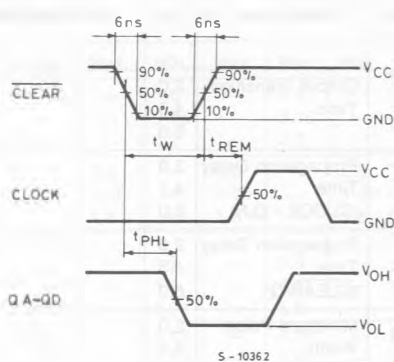
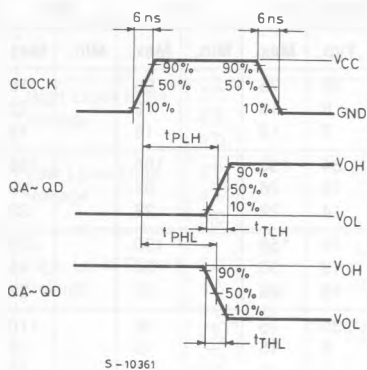
Symbol	Parameter	V_{CC}	Test Condition	$T_A = 25^\circ\text{C}$ 54HC and 74HC			-40 to 85°C 74HC		-55 to 125°C 54HC		Unit
				Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
t_{TLH} t_{THL}	Output Transition Time	2.0 4.5 6.0		— — —	30 8 7	75 15 13	— — —	95 19 16		110 22 19	ns
t_{PLH} t_{PHL}	Propagation Delay Time (CLOCK - Q,N)	2.0 4.5 6.0		— — —	64 16 14	130 26 22	— — —	165 33 28		195 39 33	ns
t_{PLH}	Propagation Delay Time (CLEAR-Q)	2.0 4.5 6.0		— — —	76 19 16	150 30 26	— — —	190 38 33		225 45 38	ns
$t_{W(H)}$ $t_{W(L)}$	Minimum Pulse Width (CLOCK)	2.0 4.5 6.0		— — —	30 8 7	75 15 13	— — —	95 19 16		110 22 19	ns
f_{MAX}	Maximum Clock Frequency	2.0 4.5 6.0		6 30 35	10 50 58	— — —	4.8 24 28	— — —	4 20 24	— — —	MHz
$t_{W(L)}$	Minimum Pulse Width (CLEAR)	2.0 4.5 6.0		— — —	30 8 7	75 15 13	— — —	95 19 16		110 22 19	ns
t_s	Minimum Set-up Data Time (SIN-PIN)	2.0 4.5 6.0		— — —	30 8 7	75 15 13	— — —	95 19 16		110 22 19	ns
t_s	Minimum Set-up Data Time (Mode Control-CK)	2.0 4.5 6.0		— — —	40 10 9	100 20 17	— — —	125 25 21	— — —	150 30 26	ns
t_{REM}	Minimum Removal Time (CLEAR)	2.0 4.5 6.0		— — —	— — —	25 5 5	— — —	30 6 6	— — —	40 8 7	ns
t_h	Minimum Hold Time SIN/PIN-CK, Mode, Ctr-CK	2.0 4.5 6.0		— — —	— — —	0 0 0	— — —	0 0 0	— — —	0 0 0	ns
C_{IN}	Input Capacitance			—	5	10	—	10		10	pF
$C_{PD} (*)$	Power Dissipation Capacitance			—	102	—	—	—			pF

Note (*) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit)

Average operating current can be obtained by the following equation.

$$I_{CC(oper)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

SWITCHING CHARACTERISTICS TEST WAVEFORM

TEST CIRCUIT I_{CC} (Opr.)